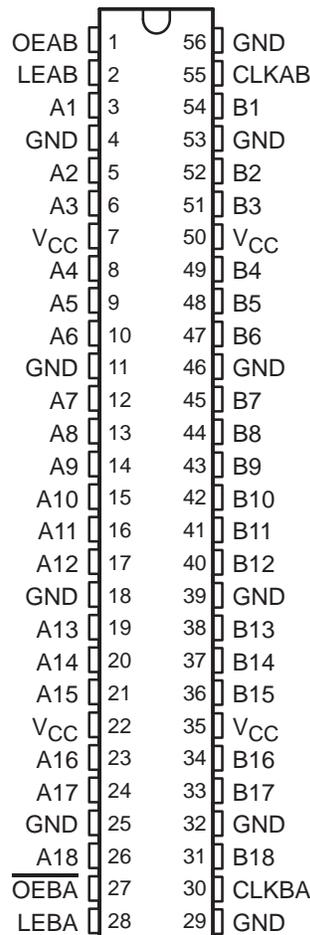


SN54LVT16501, SN74LVT16501 3.3-V ABT 18-BIT UNIVERSAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS147G – MAY 1992 – REVISED NOVEMBER 1996

- State-of-the-Art Advanced BiCMOS Technology (ABT) Design for 3.3-V Operation and Low-Static Power Dissipation
- Members of the Texas Instruments *Widebus*™ Family
- Support Mixed-Mode Signal Operation (5-V Input and Output Voltages With 3.3-V V_{CC})
- Support Unregulated Battery Operation Down to 2.7 V
- *UBT*™ (Universal Bus Transceiver) Combines D-Type Latches and D-Type Flip-Flops for Operation in Transparent, Latched, or Clocked Mode
- Typical V_{OLP} (Output Ground Bounce) < 0.8 V at $V_{CC} = 3.3$ V, $T_A = 25^\circ\text{C}$
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model ($C = 200$ pF, $R = 0$)
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Support Live Insertion
- Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Spacings

SN54LVT16501 . . . WD PACKAGE
SN74LVT16501 . . . DGG OR DL PACKAGE
(TOP VIEW)



description

The 'LVT16501 are 18-bit universal bus transceivers designed for low-voltage (3.3-V) V_{CC} operation, but with the capability to provide a TTL interface to a 5-V system environment.

Data flow in each direction is controlled by output-enable (OEAB and \overline{OEBA}), latch-enable (LEAB and LEBA), and clock (CLKAB and CLKBA) inputs. For A-to-B data flow, the devices operate in the transparent mode when LEAB is high. When LEAB is low, the A data is latched if CLKAB is held at a high or low logic level. If LEAB is low, the A-bus data is stored in the latch/flip-flop on the low-to-high transition of CLKAB. When OEAB is high, the outputs are active. When OEAB is low, the outputs are in the high-impedance state.



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 **TEXAS
INSTRUMENTS**

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SN54LVT16501, SN74LVT16501

3.3-V ABT 18-BIT UNIVERSAL BUS TRANSCEIVERS

WITH 3-STATE OUTPUTS

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description (continued)

Data flow for B to A is similar to that of A to B but uses \overline{OEBA} , LEBA, and CLKBA. The output enables are complementary (OEAB is active high and \overline{OEBA} is active low).

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor. The minimum value of the resistor is determined by the current-sinking capability of the driver. OE should be tied to GND through a pulldown resistor; the minimum value of the resistor is determined by the current-sourcing capability of the driver.

The SN74LVT16501 is available in TI's shrink small-outline (DL) and thin shrink small-outline (DGG) packages, which provide twice the input/output (I/O) pin count and functionality of standard small-outline packages in the same printed circuit board area.

The SN54LVT16501 is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74LVT16501 is characterized for operation from -40°C to 85°C .

FUNCTION TABLE†

| INPUTS | | | | OUTPUT |
|--------|------|-------|---|------------------|
| OEAB | LEAB | CLKAB | A | B |
| L | X | X | X | Z |
| H | H | X | L | L |
| H | H | X | H | H |
| H | L | ↑ | L | L |
| H | L | ↑ | H | H |
| H | L | H | X | B_0^{\ddagger} |
| H | L | L | X | B_0^{\S} |

† A-to-B data flow is shown; B-to-A flow is similar but uses \overline{OEBA} , LEBA, and CLKBA.

‡ Output level before the indicated steady-state input conditions were established, provided that CLKAB was high before LEAB went low

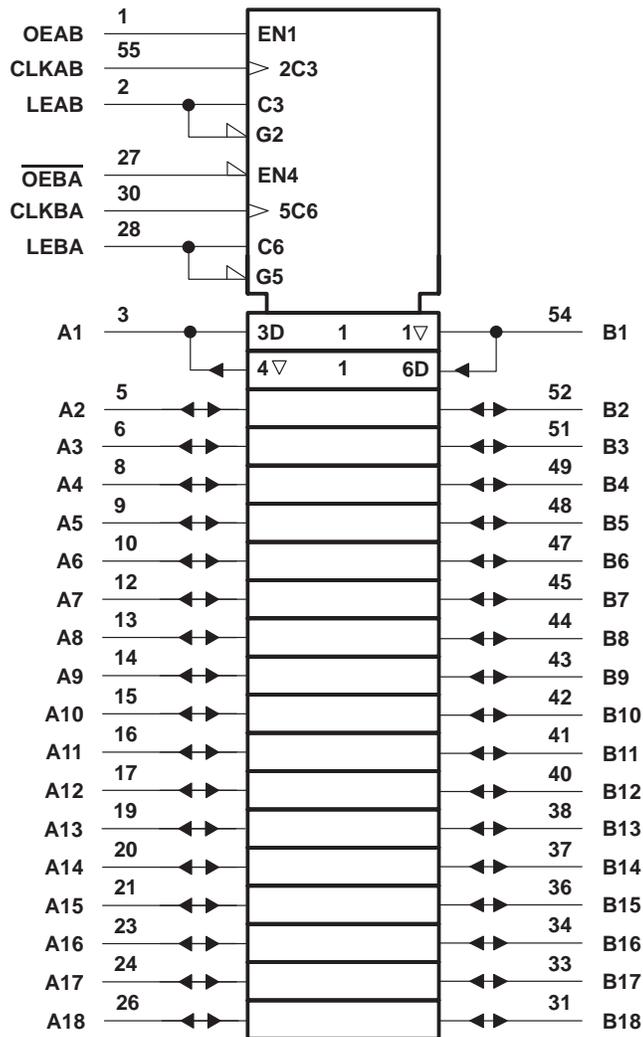
§ Output level before the indicated steady-state input conditions were established



SN54LVT16501, SN74LVT16501 3.3-V ABT 18-BIT UNIVERSAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

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logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

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WITH 3-STATE OUTPUTS

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recommended operating conditions (see Note 4)

| | | SN54LVT16501 | | SN74LVT16501 | | UNIT |
|---------------------|------------------------------------|-----------------|-----|--------------|-----|------|
| | | MIN | MAX | MIN | MAX | |
| V_{CC} | Supply voltage | 2.7 | 3.6 | 2.7 | 3.6 | V |
| V_{IH} | High-level input voltage | 2 | | 2 | | V |
| V_{IL} | Low-level input voltage | | 0.8 | | 0.8 | V |
| V_I | Input voltage | | 5.5 | | 5.5 | V |
| I_{OH} | High-level output current | | -24 | | -32 | mA |
| I_{OL} | Low-level output current | | 48 | | 64 | mA |
| $\Delta t/\Delta v$ | Input transition rise or fall rate | Outputs enabled | | 10 | 10 | ns/V |
| T_A | Operating free-air temperature | -55 | 125 | -40 | 85 | °C |

NOTE 4: Unused control inputs must be held high or low to prevent them from floating.

SN54LVT16501, SN74LVT16501
3.3-V ABT 18-BIT UNIVERSAL BUS TRANSCEIVERS
WITH 3-STATE OUTPUTS

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | | SN54LVT16501 | | | SN74LVT16501 | | | UNIT | |
|-----------------------|--|--|--|--|------|------|----------------------|------|------|------|--|
| | | | | MIN | TYP† | MAX | MIN | TYP† | MAX | | |
| V _{IK} | | V _{CC} = 2.7 V, I _I = -18 mA | | -1.2 | | | -1.2 | | | V | |
| V _{OH} | | V _{CC} = 2.7 V to 3.6 V, I _{OH} = -100 μA | | V _{CC} -0.2 | | | V _{CC} -0.2 | | | V | |
| | | V _{CC} = 2.7 V, I _{OH} = -8 mA | | 2.4 | | | 2.4 | | | | |
| | | V _{CC} = 3 V | | I _{OH} = -24 mA | | | 2 | | | | |
| | | | | I _{OH} = -32 mA | | | 2 | | | | |
| V _{OL} | | V _{CC} = 2.7 V | | I _{OL} = 100 μA | | 0.2 | | | 0.2 | | |
| | | | | I _{OL} = 24 mA | | 0.5 | | | 0.5 | | |
| | | V _{CC} = 3 V | | I _{OL} = 16 mA | | 0.4 | | | 0.4 | | |
| | | | | I _{OL} = 32 mA | | 0.5 | | | 0.5 | | |
| | | | | I _{OL} = 48 mA | | 0.55 | | | | | |
| | | | | I _{OL} = 64 mA | | | | | 0.55 | | |
| I _I | | Control pins | | V _{CC} = 3.6 V, V _I = V _{CC} or GND | | ±1 | | | ±1 | | |
| | | | | V _{CC} = 0 or 3.6 V, V _I = 5.5 V | | 10 | | | 10 | | |
| A or B ports‡ | | V _{CC} = 3.6 V | | V _I = 5.5 V | | 120 | | | 20 | | |
| | | | | V _I = V _{CC} | | 1 | | | 1 | | |
| | | | | V _I = 0 | | -5 | | | -5 | | |
| I _{off} | | V _{CC} = 0, V _I or V _O = 0 to 4.5 V | | | | | ±100 | | | μA | |
| I _I (hold) | | A or B ports | | V _{CC} = 3 V, V _I = 0.8 V | | 75 | | | 75 | | |
| | | | | V _I = 2 V | | -75 | | | -75 | | |
| I _{OZH} | | V _{CC} = 3.6 V, V _O = 3 V | | | | | 1 | | | μA | |
| I _{OZL} | | V _{CC} = 3.6 V, V _O = 0.5 V | | | | | -1 | | | μA | |
| I _{CC} | | V _{CC} = 3.6 V, V _I = V _{CC} or GND, I _O = 0, | | Outputs high | | 0.12 | | | 0.12 | | |
| | | | | Outputs low | | 5 | | | 5 | | |
| | | | | Outputs disabled | | 0.12 | | | 0.12 | | |
| ΔI _{CC} § | | V _{CC} = 3 V to 3.6 V, One input at V _{CC} - 0.6 V, Other inputs at V _{CC} or GND | | 0.2 | | | 0.2 | | | mA | |
| C _i | | V _I = 3 V or 0 | | 3.5 | | | 3.5 | | | pF | |
| C _{io} | | V _O = 3 V or 0 | | 12 | | | 12 | | | pF | |

† All typical values are at V_{CC} = 3.3 V, T_A = 25°C.

‡ Unused pins at V_{CC} or GND

§ This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.



SN54LVT16501, SN74LVT16501
3.3-V ABT 18-BIT UNIVERSAL BUS TRANSCEIVERS
WITH 3-STATE OUTPUTS

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timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

| | | SN54LVT16501 | | | | SN74LVT16501 | | | | UNIT |
|--------------------|-----------------|--|-----|-------------------------|-----|--|-----|-------------------------|-----|------|
| | | $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ | | $V_{CC} = 2.7\text{ V}$ | | $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ | | $V_{CC} = 2.7\text{ V}$ | | |
| | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| f_{clock} | Clock frequency | 0 | 150 | 0 | 125 | 0 | 150 | 0 | 125 | MHz |
| t_w | Pulse duration | LE high | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | ns |
| | | CLK high or low | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | 3.3 | |
| t_{su} | Setup time | A before CLKAB \uparrow | 1.6 | 2.1 | 1.6 | 2.1 | 1.6 | 2.1 | 1.6 | ns |
| | | B before CLKBA \uparrow | 1.6 | 2.1 | 1.6 | 2.1 | 1.6 | 2.1 | 1.6 | |
| | | A or B before LE \downarrow , $\overline{\text{CLK}}$ high | 3.1 | 2.7 | 2.6 | 1.9 | 2.6 | 1.9 | 1.9 | |
| | | A or B before LE \downarrow , $\overline{\text{CLK}}$ low | 2.6 | 2.0 | 2 | 1.3 | 2 | 1.3 | 1.3 | |
| t_h | Hold time | A or B after CLK \uparrow | 2 | 2.1 | 2 | 2.1 | 2 | 2.1 | 2 | ns |
| | | A or B after LE \downarrow | 1.3 | 1.2 | 0.9 | 1.2 | 0.9 | 1.2 | 0.9 | |

switching characteristics over recommended operating free-air temperature range, $C_L = 50\text{ pF}$ (unless otherwise noted) (see Figure 1)

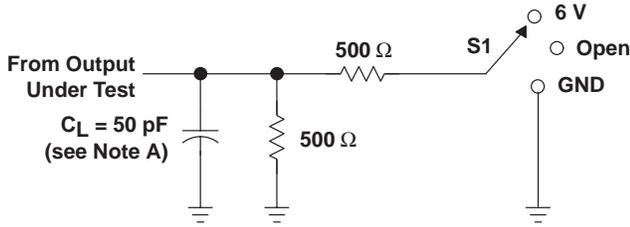
| PARAMETER | FROM (INPUT) | TO (OUTPUT) | SN54LVT16501 | | | | SN74LVT16501 | | | | UNIT | |
|------------------|----------------------------------|-------------|--|-----|-------------------------|------|--|---------------|-----|-------------------------|------|-----|
| | | | $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ | | $V_{CC} = 2.7\text{ V}$ | | $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ | | | $V_{CC} = 2.7\text{ V}$ | | |
| | | | MIN | MAX | MIN | MAX | MIN | TYP \dagger | MAX | MIN | | MAX |
| f_{max} | | | 150 | | 125 | | | 150 | | 125 | MHz | |
| t_{PLH} | B or A | A or B | 1.7 | 5.4 | | 6.8 | 1.7 | 3 | 5.4 | | 6.8 | ns |
| t_{PHL} | | | 1.6 | 6 | | 7.8 | 1.6 | 3.2 | 5.9 | | 7.7 | |
| t_{PLH} | LEBA or LEAB | A or B | 2.3 | 7.3 | | 9 | 2.3 | 4 | 7 | | 8.5 | ns |
| t_{PHL} | | | 2.7 | 8.2 | | 9.8 | 2.7 | 4.3 | 7.9 | | 9.7 | |
| t_{PLH} | CLKBA or CLKAB | A or B | 2.5 | 8.3 | | 9.7 | 2.5 | 4.1 | 7.9 | | 9.2 | ns |
| t_{PHL} | | | 3.5 | 9.4 | | 10.7 | 3.5 | 5.4 | 8.9 | | 10.4 | |
| t_{PZH} | $\overline{\text{OEBA}}$ or OEAB | A or B | 1.2 | 5.1 | | 6.1 | 1.2 | 3 | 5 | | 5.9 | ns |
| t_{PZL} | | | 1.5 | 5.9 | | 7 | 1.5 | 3 | 5.8 | | 6.9 | |
| t_{PHZ} | $\overline{\text{OEBA}}$ or OEAB | A or B | 2.7 | 7.5 | | 8.5 | 2.7 | 4.6 | 7.4 | | 8.3 | ns |
| t_{PLZ} | | | 2.8 | 6.8 | | 7.5 | 2.8 | 4.7 | 6.7 | | 7.2 | |

\dagger All typical values are at $V_{CC} = 3.3\text{ V}$, $T_A = 25^\circ\text{C}$.

SN54LVT16501, SN74LVT16501
3.3-V ABT 18-BIT UNIVERSAL BUS TRANSCEIVERS
WITH 3-STATE OUTPUTS

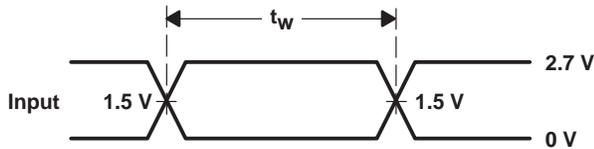
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PARAMETER MEASUREMENT INFORMATION

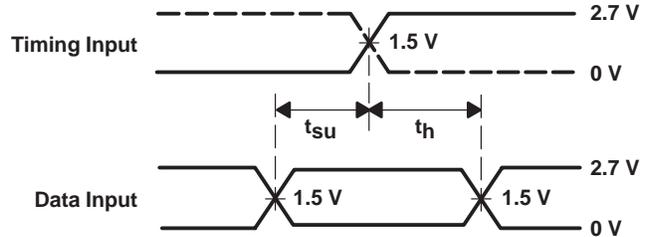


LOAD CIRCUIT

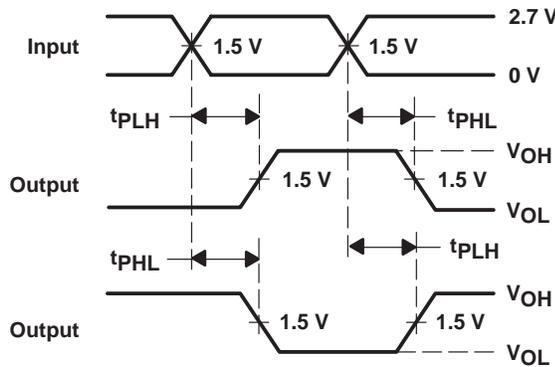
| TEST | S1 |
|-------------------|------|
| t_{PLH}/t_{PHL} | Open |
| t_{PLZ}/t_{PZL} | 6 V |
| t_{PHZ}/t_{PZH} | GND |



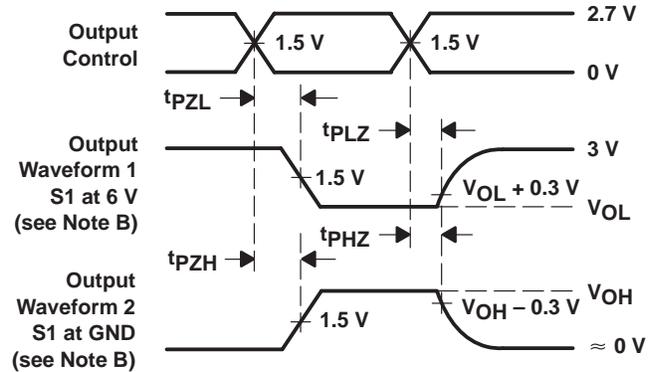
VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING

- NOTES: A. C_L includes probe and jig capacitance.
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10$ MHz, $Z_O = 50 \Omega$, $t_r \leq 2.5$ ns, $t_f \leq 2.5$ ns.
 D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead finish/ Ball material (6) | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|---------------|--------------|--------------------|------|----------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|---------|
| SN74LVT16501DGGR | ACTIVE | TSSOP | DGG | 56 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | LVT16501 | Samples |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

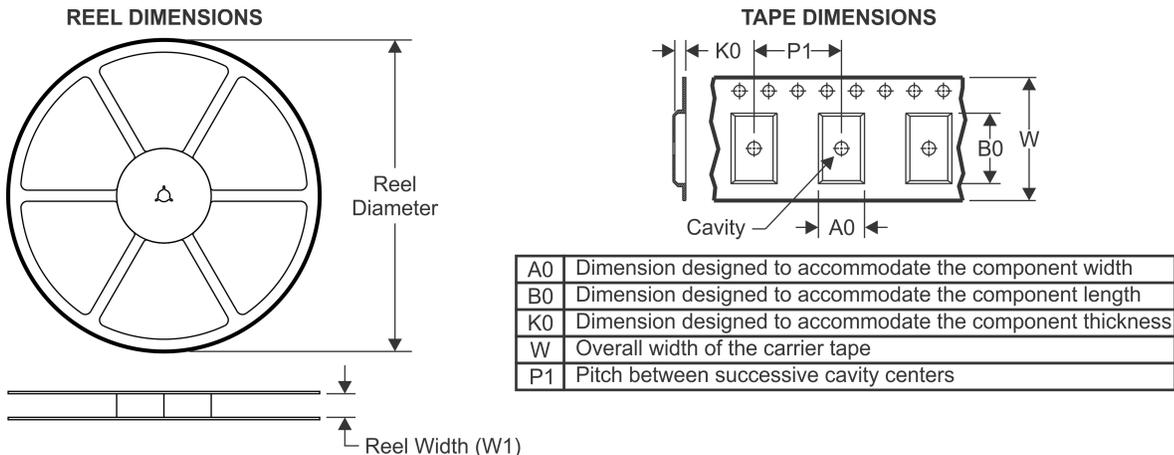
(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

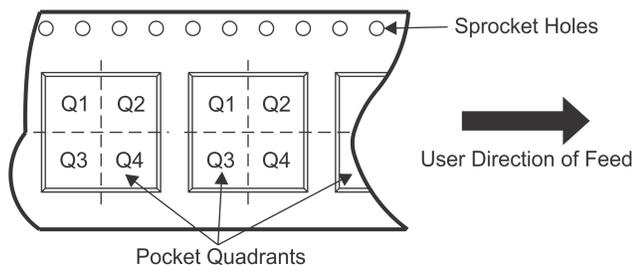
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TAPE AND REEL INFORMATION



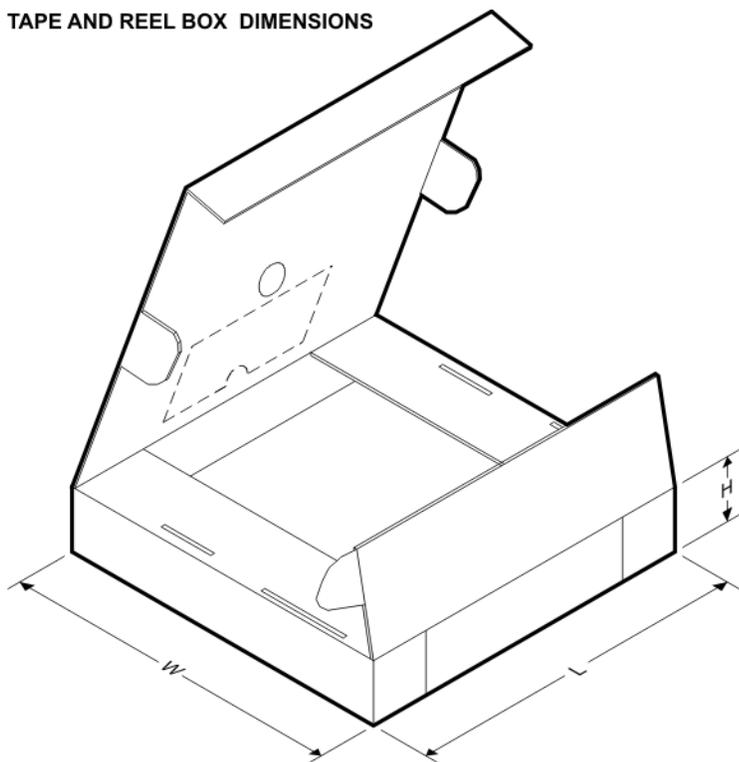
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

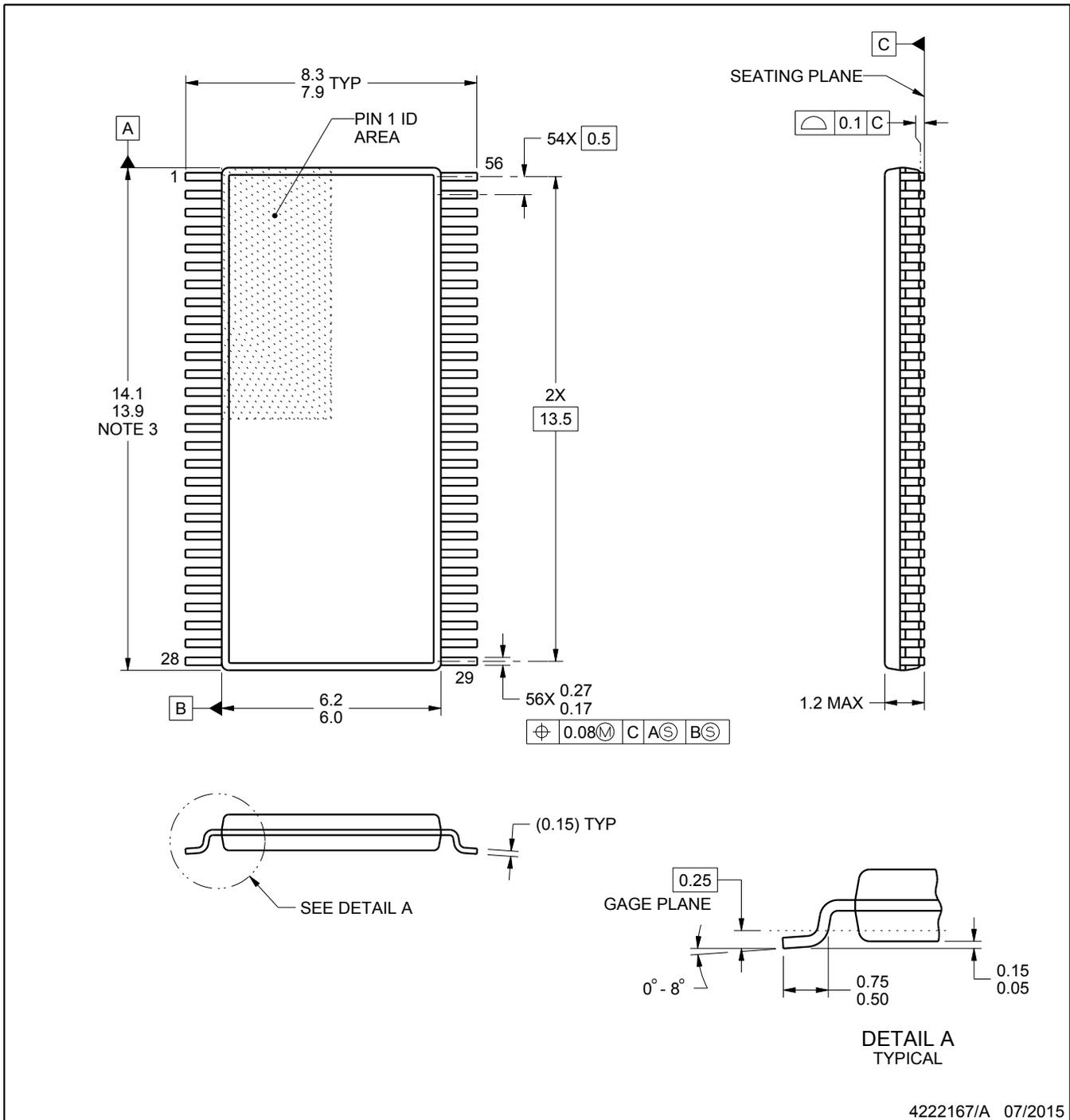
| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74LVT16501DGGR | TSSOP | DGG | 56 | 2000 | 330.0 | 24.4 | 8.6 | 15.6 | 1.8 | 12.0 | 24.0 | Q1 |

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74LVT16501DGGR | TSSOP | DGG | 56 | 2000 | 367.0 | 367.0 | 45.0 |



4222167/A 07/2015

NOTES:

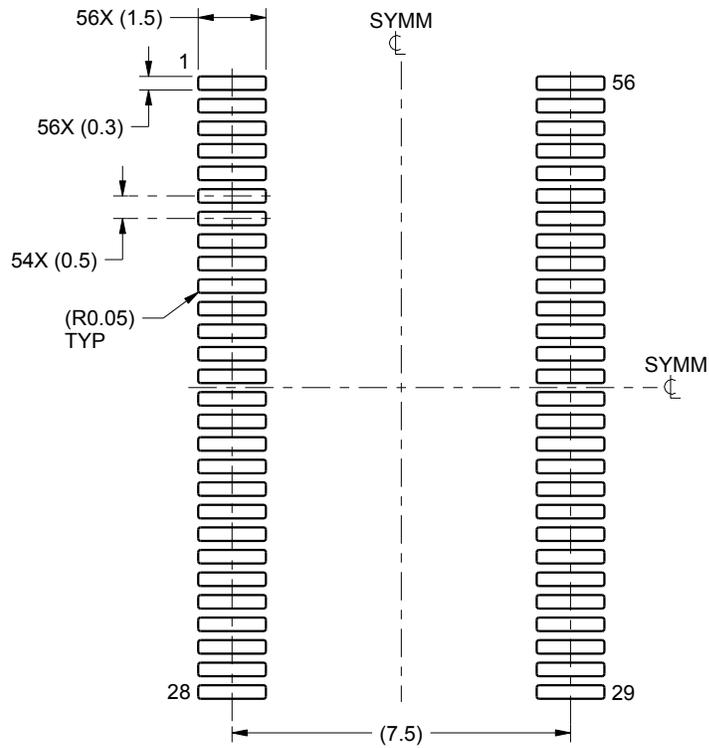
- All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- This drawing is subject to change without notice.
- This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
- Reference JEDEC registration MO-153.

EXAMPLE BOARD LAYOUT

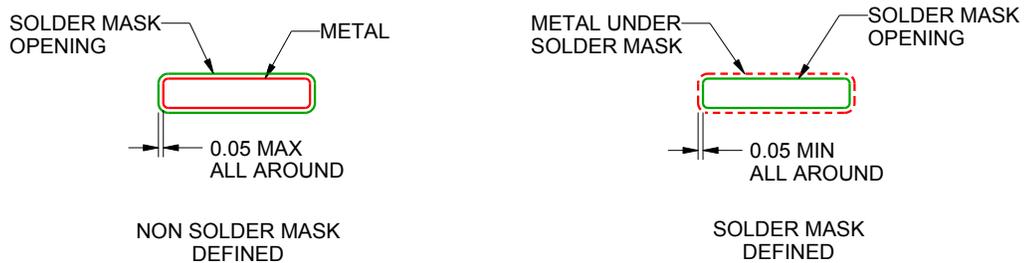
DGG0056A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE
SCALE:6X



SOLDER MASK DETAILS

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NOTES: (continued)

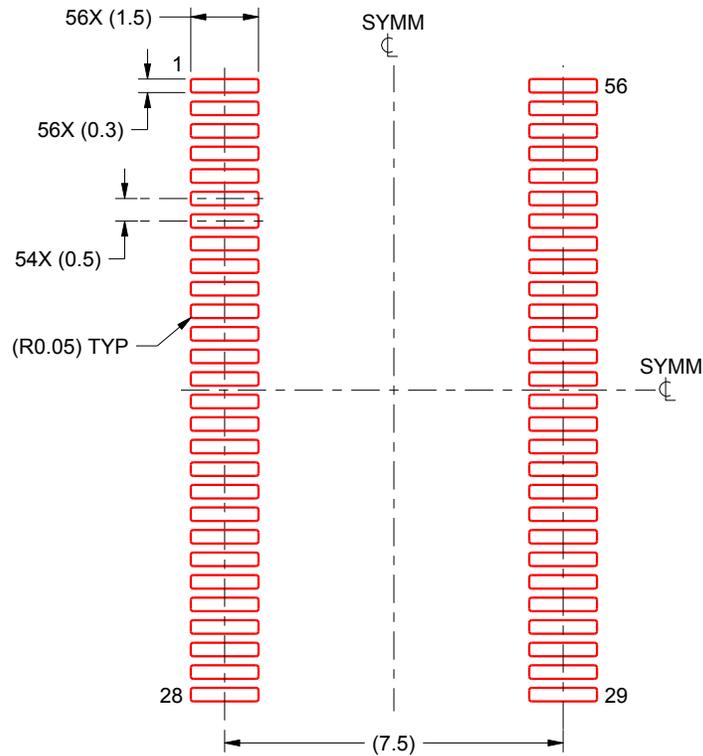
- 5. Publication IPC-7351 may have alternate designs.
- 6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

DGG0056A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:6X

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NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

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